



SPECIFICATION

宏致電子有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808

FAX: +886-3-463-1800

SPEC. NO.: PS-50019-XXXXX-XXX REVISION: 0

PRODUCT NAME: 0.5mm PITCH BTB SMT S/T D/R CONNECTOR

PRODUCT NO: PS-50019-XXXXX-XXX

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2008/12/06 TR-FM-73015G



TITLE: 0.5MM PITCH BTB SMT S/T D/R CONNECTOR

RELEASE DATE: 2008/12/06

REVISION: 0

ECN No: 0812036

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Aces P/N: **50019 series**

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1 Revision History

Rev.	ECN #	Revision Description	Approved	Date
O	ECN-0812036	NEW SPEC	JASON	2008/12/06

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2 SCOPE

This specification covers performance, tests and quality requirements for **0.50mm pitch BTB connector**. ACES P/N: **50019 Series; 50020 Series; 50031 Series; 50149 Series; 50152 Series**.

3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy
 - Finish: (a) Contact Area: **Gold plated based on order information**
 - (b) Under plate: **Nickel-plated all over**
- 4.2.2 Housing: Thermoplastic High Temp., UL94V-0

4.3 Ratings

- 4.3.1 Voltage: **50 Volts AC (per pin)**
- 4.3.2 Current: **0.5 Amperes (per pin)**
- 4.3.3 Operating Temperature : **-40°C to +80°C**

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard				
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.				
ELECTRICAL						
Item	Requirement	Standard				
Low-signal Level Contact Resistance	55 m Ω Max.(initial)per contact ΔR 10 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)				
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Dielectric Withstanding Voltage	300 VAC Min. at sea level for 1 minute. No discharge, flashover or breakdown. Current leakage: 1 mA max.	Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current after:0.5 A/Power contact. The temperature rise above ambient shall not exceed 30°C The ambient condition is still air at 25°C (EIA-364-70 METHOD 2)				
MECHANICAL						
Item	Requirement	Standard				
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 \pm 3mm/min. (EIA-364-09)				
Mating / Unmating Forces	Unit: Kg				Operation Speed : 25.4 \pm 3 mm/minute. Measure the force required to mate/Unmate connector. (EIA-364-13)	
	Pins	Mating Force(Max)		Unmating Force(Min)		
		Initial	Final	Initial		Final
	<20	2.0	1.0	0.2		0.2
	22~40	2.0	1.0	0.4		0.3
	42~80	5.0	4.0	0.5		0.4
82~120	5.0	4.0	0.8	0.6		
122~200	8.0	6.0	0.8	0.6		



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Terminal / Housing Retention Force	0.2kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.
Fitting Nail /Housing Retention Force	0.2kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.
Vibration	1 µs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 µs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Wave Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Solder Temp. : 265±5°C, 10±0.5sec.
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Pre Heat : 150°C~180°C, 60~90sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 3	Mate module and subject to follow condition for 5 cycles. 1 cycles: -40 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition A)

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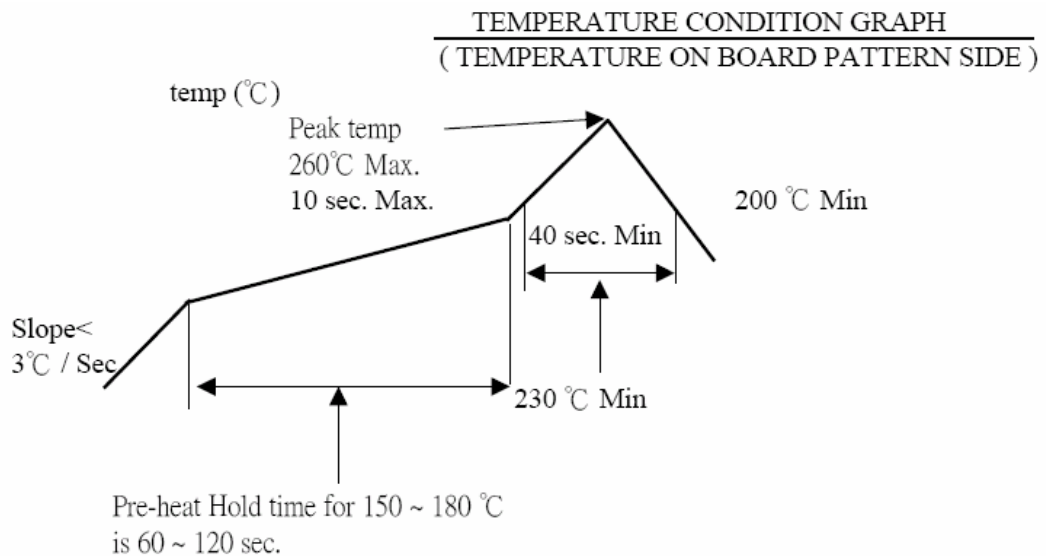
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Humidity	See Product Qualification and Test Sequence Group 3	Mated Connector 40°C, 90~95% RH, Reffer to Method II. (EIA-364-31, Test condition A)
Temperature life	See Product Qualification and Test Sequence Group 4	Subject mated connectors to temperature life at 85°C for 96 hours . Measure Signal. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 5	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 8 hours . (EIA-364-26, Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	And then into solder bath, Temperature at 255 ±5°C , for 4-5 sec . (EIA-364-52)

Note. Flowing Mixed Gas shall be conduct by customer request.

6 INFRARED REFLOW CONDITION

6.1. Lead-free Process



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8	9	
	Test Sequence									
Examination of Product				1、7	1、6	1、4			1	
Low-signal Level Contact Resistance		1、5	1、4	2、10	2、9	2、5			3	
Insulation Resistance				3、9	3、8					
Dielectric Withstanding Voltage				4、8	4、7					
Mating / Unmating Forces		2、4								
Temperature rise	1									
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Fitting Nail /Housing Retention Force								2		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	

单击下面可查看定价，库存，交付和生命周期等信息

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